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FXLA0104 Low-Voltage Dual-Supply 4-Bit Voltage Translator with Configurable Voltage Supplies and Signal Levels, 3-State Outputs, and Auto Direction Sensing

Features

- Bi-Directional Interface betw een Tw o Levels: from 1.1 V to 3.6 V
- Fully Configurable: Inputs and Outputs Track V_{CC}
- Non-Preferential Pow er-Up; Either V_{CC} May Be Pow ered Up First
- Outputs Switch to 3-State if Either V_{CC} is at GND
- Pow er-Off Protection
- Bus-Hold on Data Inputs Eliminates the Need for Pull-Up Resistors; Do Not Use Pull-Up Resistors on A or B Ports
- Control Input (OE) Referenced to V_{CCA} Voltage
- Available in the 12-Lead, 1.7 mm x 2.0 mm UMLP Package
- Direction Control Not Necessary
- 100 Mbps Throughput when Translating Between
 1.8 V and 2.5 V
- ESD Protection Exceeds:
 - 6 kV HBM (per JESD22-A114 & Mil Std 883e 3015.7)
 - 2 kV CDM (per ESD STM 5.3)

Applications

Cell Phone, PDA, Digital Camera, Portable GPS

Description

The FXLA0104 is a configurable dual-voltage supply translator for both uni-directional and bi-directional voltage translation betw een two logic levels. The device allows translation betw een voltages as high as 3.6 V to as low as 1.1 V. The A port tracks the V_{CCA} level and the B port tracks the V_{CCB} level. This allows for bi-directional voltage translation over a variety of voltage levels: 1.2 V, 1.5 V, 1.8 V, 2.5 V, and 3.3 V.

The device remains in three-state as long as either V_{CC}=0V, allowing either V_{CC} to be powered up first. Internal power-down control circuits place the device in 3-state if either V_{CC} is removed.

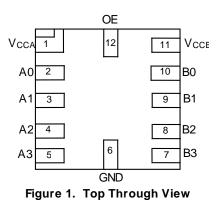
The OE input, when LOW, disables both the A and B ports by placing them in a 3-state condition. The OE input is supplied by $V_{\rm CCA}.$

The FXLA0104 supports bi-directional translation without the need for a direction control pin. The two ports of the device have auto-direction sense capability. Either port may sense an input signal and transfer it as an output signal to the other port.

| Ordering I | nformation |
|------------|------------|
|------------|------------|

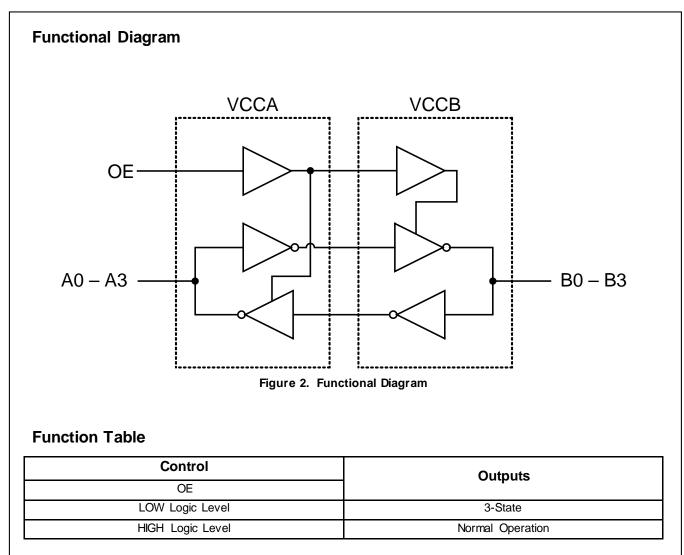
| Part Number | Operating Temperature Range | Top Mark | Package | Packing Method |
|-------------|-----------------------------------|----------|--|-----------------------------|
| FXLA0104QFX | -40 to 85°C | XU | 12-Lead, 1.7 mm x 2.0 mm Ultrathin Molded Leadless Package (UMLP) | 5000 Units Tape and Reel |

Pin Configuration



Pin Definitions

| Pin # | Name | Description |
|-------|------------------|----------------------------------|
| 1 | Vcca | A-Side Pow er Supply |
| 2 | A0 | A-Side Inputs or 3-State Outputs |
| 3 | A1 | A-Side Inputs or 3-State Outputs |
| 4 | A2 | A-Side Inputs or 3-State Outputs |
| 5 | A3 | A-Side Inputs or 3-State Outputs |
| 6 | GND | Ground |
| 7 | B3 | B-Side Inputs or 3-State Outputs |
| 8 | B2 | B-Side Inputs or 3-State Outputs |
| 9 | B1 | B-Side Inputs or 3-State Outputs |
| 10 | B0 | B-Side Inputs or 3-State Outputs |
| 11 | V _{CCB} | B-Side Pow er Supply |
| 12 | OE | Output Enable Input |



Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Condition | Min. | Max. | Unit |
|------------------|--|--|------|-----------------------|------|
| Vcc | Supply Voltage | Vcca | -0.5 | 4.6 | V |
| VCC | Supply Vollage | V _{CCB} | -0.5 | 4.6 | v |
| VI | DC Input Voltage | VO Ports A and B | -0.5 | 4.6 | V |
| ۷I | DC liput Voltage | Control Input (OE) | -0.5 | 4.6 | v |
| | | Output 3-State | -0.5 | 4.6 | |
| Vo | Output Voltage ⁽²⁾ | Output Active (A _n) | -0.5 | V _{CCA} +0.5 | V |
| | | Output Active (B _n) | -0.5 | V _{CCB} +0.5 | |
| l _{IK} | DC Input Diode Current | V _{IN} <0V | | -50 | mA |
| la.c | DC Output Diada Ourrant | V _O <0V | | -50 | mA |
| юк | DC Output Diode Current | Vo>Vcc | | +50 | ШA |
| IOH/IOL | DC Output Source/Sink Curr | ent | -50 | +50 | mA |
| lcc | DC V _{CC} or Ground Current (| per Supply Pin) | | ±100 | mA |
| T _{STG} | Storage Temperature Range | 9 | -65 | +150 | °C |
| PD | Pow er Dissipation | | | 17 | mW |
| FSD | Electrostatic Discharge | Human Body Model (per JESD22- A114 & Mil Std 883e 3015.7) | | 6 | kV |
| EGD | Capability | Charged Device Model (per ESD STM 5.3) | | 2 | κV |

Notes:

1. I_0 absolute maximum ratings must be observed.

2. All unused inputs and input/outputs must be held at V_{CCi} or GND.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. ON Semiconductor does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Condition | Min. | Max. | Unit |
|-----------------|--|--|------|------------------|------|
| V _{CC} | Pow er Supply | Operating V _{CCA} or V _{CCB} | 1.1 | 3.6 | V |
| Vin | Input Voltage | Ports A and B | 0 | 3.6 | V |
| V IN | liput voltage | Control Input (OE) | 0 | V _{CCA} | V |
| TA | Operating Temperature, Free Air | | -40 | +85 | °C |
| dt/dV | Minimum Input Edge Rate | $V_{CCA/B} = 1.1$ to 3.6 V | | 10 | ns/V |
| Θ_{JA} | Thermal Resistance: Junction-to-Ambient | | | 300 | °C/W |
| ΘJC | Thermal Resistance: Junction-to-Case | | | 165 | °C/W |

Power-Up/Power-Down Sequence

FXL translators offer an advantage in that either V_{CC} may be powered up first. This benefit derives from the chip design. When either V_{CC} is at 0V, outputs are in a high-impedance state. The control input (OE) is designed to track the V_{CCA} supply.

The recommended power-up sequence is:

- 1. Apply pow er to the first V_{CC} .
- 2. Apply pow er to the second V_{CC} .
- 3. Drive the OE input HIGH to enable the device.

The recommended power-down sequence is:

- 1. Drive OE input LOW to disable the device.
- 2. Remove powerfrom either $V_{CC}.$
- 3. Remove power from other $V_{CC.}$

Pull-Up/Pull-Down Resistors

<u>Do not use pull-up or pull-down resistors</u>. This device has bus-hold circuits: pull-up or pull-down resistors are not recommended because they interfere with the output state. The current through these resistors may exceed the hold drive, $I_{I(HOLD)}$ and/or $I_{I(OD)}$ bus-hold currents, resulting in data transition and/or autodirection sensing failures. The bus-hold feature eliminates the need for extra resistors.

DC Electrical Characteristics

 $T_A=-40$ to $85^{\circ}C$

| Symbol | Parameter | Condition | V _{CCA} (V) | V _{CCB} (V) | Min. | Тур. | Max. | Unit | |
|------------------|--|--|-------------------------|----------------------|----------------------|------|----------------------|------|--|
| | | | 2.70 to 3.60 | | 2.00 | | | | |
| | | | 2.30 to 2.70 | | 1.60 | | | | |
| VIHA | | Data Inputs An Control Pin OE | 1.65 to 2.30 | 1.10 to 3.60 | .65xV _{CCA} | | | V | |
| | | | 1.40 to 1.65 | | .65xV _{CCA} | | | | |
| | High-Level Input Voltage | | 1.10 to 1.40 | | .90xV _{CCA} | | | | |
| | | | | 2.70 to 3.60 | 2.00 | | | | |
| | | | | 2.30 to 2.70 | 1.60 | | | | |
| VIHB | | Data Inputs B _n | 1.10 to 3.60 | 1.65 to 2.30 | .65xV _{CCB} | | | V | |
| | | | | 1.40 to 1.65 | .65xV _{CCB} | | | | |
| | | | | 1.10 to 1.40 | .90xV _{CCB} | | | | |
| | | | 2.70 to 3.60 | | | | .80 | | |
| | | | 2.30 to 2.70 | | | | .70 | | |
| VILA | | Data Inputs An Control Pin OE | 1.65 to 2.30 | 1.10 to 3.60 | | | .35xV _{CCA} | V | |
| | | | 1.40 to 1.65 | | | | .35xVcca | | |
| | Low -Level Input | | 1.10 to 1.40 | | | | .10xVcca | | |
| | Voltage | | | 2.70 to 3.60 | | | .80 | | |
| | 5 | | | 2.30 to 2.70 | | | .70 | | |
| V _{ILB} | | Data Inputs B _n | 1.10 to 3.60 | 1.65 to 2.30 | | | .35xV _{CCB} | V | |
| | | | | 1.40 to 1.65 | | | .35xV _{CCB} | | |
| | | | | 1.10 to 1.40 | | | .10xV _{CCB} | | |
| Voha | High-Leyel Output | юн=-4 μА | 1.10 to 3.60 | 1.10 to 3.60 | V _{CCA} 4 | | | | |
| Vонв | Voltage ⁽³⁾ | юн=-4 μА | 1.10 to 3.60 | 1.10 to 3.60 | V _{ССВ} 4 | | | V | |
| Vola | Low -Level Output | l _{OL} =4 µA | 1.10 to 3.60 | 1.10 to 3.60 | | | .4 | | |
| V _{OLB} | Voltage ⁽ 3 ⁾ | loL=4 µA | 1.10 to 3.60 | 1.10 to 3.60 | | | .4 | V | |
| | | V _{IN} =0.8 V | 3.00 | 3.00 | 75.0 | | | | |
| | | V _{IN} =2.0 V | 3.00 | 3.00 | -75.0 | | | | |
| | | V _{IN} =0.7 V | 2.30 | 2.30 | 45.0 | | | | |
| | | V _{IN} =1.6 V | 2.30 | 2.30 | -45.0 | | | | |
| | I(HOLD) Bus-Hold Input Minimum Drive Current | V _{IN} =0.57 V | 1.65 | 1.65 | 25.0 | | | | |
| l(HOLD) | | V _{IN} =1.07 V | 1.65 | 1.65 | -25.0 | | | μA | |
| | | V _{IN} =0.49 V | 1.40 | 1.40 | 11.0 | | | | |
| | | V _{IN} =0.91 V | 1.40 | 1.40 | -11.0 | | | | |
| | | V _{IN} =0.91 V V _{IN} =0.11 V | V _{IN} =0.11 V | 1.10 | 1.10 | | 4.0 | | |
| | | V _{IN} =0.99 V | 1.10 | 1.10 | | -4.0 | | | |

Note:

3. This is the output voltage for static conditions. Dynamic drive specifications are given in the Dynamic Output Electrical Characteristics table.

Continued on following page...

DC Electrical Characteristics (Continued)

T_A=-40 to 85°C.

| Symbol | Parameter | Condition | V _{CCA} (V) | V _{CCB} (V) | Min. | Max. | Unit |
|---------|-----------------------------|--|----------------------|----------------------|--------|-------|------|
| | | | 3.60 | 3.60 | 450.0 | | |
| | Bus-Hold Input | | 2.70 | 2.70 | 300.0 | | |
| I(ODH) | Overdrive High | Data Inputs An, Bn | 1.95 | 1.95 | 200.0 | | μA |
| | Current ⁽⁴⁾ | | 1.60 | 1.60 | 120.0 | | |
| | | | 1.40 | 1.40 | 80.0 | | |
| | | | 3.60 | 3.60 | -450.0 | | |
| | Bus-Hold Input | | 2.70 | 2.70 | -300.0 | | |
| II(ODL) | Overdrive Low | Data Inputs An, Bn | 1.95 | 1.95 | -200.0 | | μA |
| | Current ⁽⁵⁾ | | 1.60 | 1.60 | -120.0 | | |
| | | | 1.40 | 1.40 | -80.0 | | |
| h | Input Leakage Current | Control Inputs OE, VI=V _{CCA} or GND | 1.10 to 3.60 | 3.60 | | ±1.0 | μA |
| | Pow er-Off Leakage | $A_n V_0=0 V$ to 3.6 V | 0 | 3.60 | | ±2.0 | |
| OFF | Current | B _n V _O =0 V to 3.6 V | 3.60 | 0 | | ±2.0 | μA |
| | | A _n , B _n V _O =0 V or 3.6 V, OE=V _{IL} | 3.60 | 3.60 | | ±5.0 | |
| loz | 3-State Output Leakage | A _n V _O =0 V or 3.6 V, OE=V _{CCA} | 3.60 | 0 | | ±5.0 | μA |
| | | B _n V _O =0 V or 3.6 V, OE=3.6V | 0 | 3.60 | | ±5.0 | |
| ICCA/B | Quiescent Şupply | VI=V _{CCI} or GND; I _O =0, OE=VIH | 1.10 to 3.60 | 1.10 to 3.60 | | 10.0 | μA |
| lccz | Current ^(6' 7) | V _I =V _{CCI} or GND; I _O =0, OE=GND | 1.10 to 3.60 | 1.10 to 3.60 | | 10.0 | μA |
| ICCA | | V _I =V _{CCB} or GND; I ₀ =0 B-to-A Direction; OE=V _{IH} | 0 | 1.10 to 3.60 | | -10.0 | μA |
| | Quiescent Supply Current | V _I =V _{CCA} or GND; I _O =0 A-to-B Direction | 1.10 to 3.60 | 0 | | 10.0 | |
| Іссв | | V _I =V _{CCA} or GND; I _O =0, A-to-B Direction, OE=V _{IH} | 1.10 to 3.60 | 0 | | -10.0 | μA |
| | | V _I =V _{CCB} or GND; I _O =0 B-to-A Direction | 0 | 1.10 to 3.60 | | 10.0 | |

Notes:

4. An external drive must source at least the specified current to switch LOW-to-HIGH.

5. An external drive must source at least the specified current to switch HIGH-to-LOW.

6. $V_{CCI}\xspace$ is the $V_{CC}\xspace$ associated with the input side.

7. Reflects current per supply, V_{CCA} or V_{CCB} .

FXLA0104 — Low-Voltage Dual-Supply 4-Bit Voltage Translator

Dynamic Output Electrical Characteristic

A Port (A_n)

Output Load: C_L=15 pF, $R_L \ge M\Omega$ (C_{VO}=4 pF), T_A =-40 to 85°C

| Symbol | Parameter | V _{CCA} =3.0 V to 3.6 V | | V _{CCA} =2.3 V to 2.7 V | | V _{CCA} =1.65 V to 1.95 V | | V _{CCA} =1.4 V to 1.6 V | | V _{CCA} =1.1 V to 1.3 V | Unit |
|-------------------|--|-------------------------------------|------|-------------------------------------|------|---------------------------------------|-----|-------------------------------------|------|-------------------------------------|------|
| | | Тур. | Max. | Тур. | Max. | Тур. | Max | Тур. | Max. | Тур. | |
| t _{rise} | Output Rise Time A Port ⁽ 9 ⁾ | | 3.0 | | 3.5 | | 4.0 | | 5.0 | 7.5 | ns |
| t _{fall} | Output Fall Time A Port ⁽¹⁰⁾ | | 3.0 | | 3.5 | | 4.0 | | 5.0 | 7.5 | ns |
| Юнр | Dynamic Output Current High ⁽ 9 ⁾ | -11.4 | | -7.5 | | -4.7 | | -3.2 | | -1.7 | mA |
| lold | Dynamic Output Current Low ⁽¹⁰⁾ | +11.4 | | +7.5 | | +4.7 | | +3.2 | | +1.7 | mA |

B Port (B_n)

Output Load: C_L=15 pF, $R_L \ge M\Omega$ (C_{VO}=5 pF), T_A=-40 to 85°C

| Symbol | Parameter | V _{CCB} =3.0 V to 3.6 V | | V _{CCB} =2.3 V to 2.7 V | | V _{CCB} =1.65 V to 1.95 V | | V _{CCB} =1.4 V to 1.6 V | | V _{CCB} =1.1 V to 1.3 V | Unit |
|-------------------|--|-------------------------------------|------|-------------------------------------|------|---------------------------------------|-----|-------------------------------------|------|-------------------------------------|------|
| | | Тур. | Max. | Тур. | Max. | Тур. | Max | Тур. | Max. | Тур. | |
| t _{rise} | Output Rise Time B Port ⁽ 9 ⁾ | | 3.0 | | 3.5 | | 4.0 | | 5.0 | 7.5 | ns |
| t _{fall} | Output Fall Time B Port ⁽¹⁰⁾ | | 3.0 | | 3.5 | | 4.0 | | 5.0 | 7.5 | ns |
| Юнд | Dynamic Output Current High ⁽⁹⁾ | -12.0 | | -7.9 | | -5.0 | | -3.4 | | -1.8 | mA |
| lold | Dynamic Output Current Low ⁽¹⁰⁾ | +12.0 | | +7.9 | | +5.0 | | +3.4 | | +1.8 | mA |

Notes:

8. Dynamic output characteristics are guaranteed, but not tested.

9. See Figure 7.

10. See Figure 8.

AC Characteristics

 $V_{CCA} = 3.0 V$ to 3.6 V, T_A =-40 to 85°C

| Symbol | Parameter | V _{CCB} =3.0 V to 3.6 V | | V _{CCB} =2.3 V to 2.7 V | | V _{CCB} =1.65 V to 1.95 V | | V _{CCB} =1.4 V to 1.6 V | | V _{CCB} =1.1 V to 1.3 V | Unit |
|------------------------------------|-----------------------------------|-------------------------------------|------|-------------------------------------|------|---------------------------------------|-----|-------------------------------------|------|-------------------------------------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max | Min. | Max. | Тур. | |
| t _{PLH} ,t _{PHL} | A to B | 0.2 | 4.0 | 0.3 | 4.2 | 0.5 | 5.4 | 0.6 | 6.8 | 6.9 | ns |
| IPLH, IPHL | B to A | 0.2 | 4.0 | 0.2 | 4.1 | 0.3 | 5.0 | 0.5 | 6.0 | 4.5 | ns |
| t _{PZL} ,t _{PZH} | OE to A, OE to B | | 1.7 | | 1.7 | | 1.7 | | 1.7 | 1.7 | μs |
| t _{SKEW} | A Port, B Port ⁽¹¹⁾ | | 0.5 | | 0.5 | | 0.5 | | 1.0 | 1.0 | ns |

V_{CCA} = 2.3 V to 2.7 V, T_{A} =-40 to 85°C

| Symbol | Parameter | | | V _{ссв} = to 2 | V _{CCB} =2.3 V to 2.7 V | | V _{CCB} =1.65 V to 1.95 V | | ⊧1.4 V .6 V | V _{CCB} =1.1 V to 1.3 V | Unit |
|------------------------------------|-----------------------------------|------|------|----------------------------|-------------------------------------|------|---------------------------------------|------|----------------|-------------------------------------|------|
| | | Min. | Max. | Min. | Max. | Min. | Мах | Min. | Max. | Тур. | |
| tou u tou | A to B | 0.2 | 4.1 | 0.4 | 4.5 | 0.5 | 5.6 | 0.8 | 6.9 | 7.0 | ns |
| t _{PLH} ,t _{PHL} | B to A | 0.3 | 4.2 | 0.4 | 4.5 | 0.5 | 5.5 | 0.5 | 6.5 | 4.8 | ns |
| t _{PZL} ,t _{PZH} | OE to A, OE to B | | 1.7 | | 1.7 | | 1.7 | | 1.7 | 1.7 | μs |
| tskew | A Port, B Port ⁽¹¹⁾ | | 0.5 | | 0.5 | | 0.5 | | 1.0 | 1.0 | ns |

$V_{CCA} = 1.65 \text{ V}$ to 1.95 V, $T_A = -40 \text{ to } 85^{\circ}\text{C}$

| Symbol | Parameter | V _{CCB} =3.0 V to 3.6 V | | V _{CCB} =2.3 V to 2.7 V | | V _{CCB} =1.65 V to 1.95 V | | V _{CCB} =1.4 V to 1.6 V | | V _{CCB} =1.1 V to 1.3 V | Unit |
|------------------------------------|-----------------------------------|-------------------------------------|------|-------------------------------------|------|---------------------------------------|-----|-------------------------------------|------|-------------------------------------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max | Min. | Max. | Тур. | |
| tou u tou u | A to B | 0.3 | 5.0 | 0.5 | 5.5 | 0.8 | 6.7 | 0.9 | 7.5 | 7.5 | ns |
| t _{PLH} ,t _{PHL} | B to A | 0.5 | 5.4 | 0.5 | 5.6 | 0.8 | 6.7 | 1.0 | 7.0 | 5.4 | ns |
| t _{PZL} ,t _{PZH} | OE to A, OE to B | | 1.7 | | 1.7 | | 1.7 | | 1.7 | 1.7 | μs |
| tskew | A Port, B Port ⁽¹¹⁾ | | 0.5 | | 0.5 | | 0.5 | | 1.0 | 1.0 | ns |

Note:

11. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (A_n or B_n) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW) *(see Figure 10).* Skew is guaranteed, but not tested.

AC Characteristics (Continued)

 V_{CCA} = 1.4 V to 1.6 V, T_A=-40 to 85°C

| Symbol | Parameter | V _{CCB} =3.0 V to 3.6 V | | V _{CCB} =2.3 V to 2.7 V | | V _{CCB} =1.65 V to 1.95 V | | V _{CCB} =1.4 V to 1.6 V | | V _{CCB} =1.1 V to 1.3 V | Unit |
|------------------------------------|-----------------------------------|-------------------------------------|------|-------------------------------------|------|---------------------------------------|-----|-------------------------------------|------|-------------------------------------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max | Min. | Max. | Тур. | |
| t _{PLH} ,t _{PHL} | A to B | 0.5 | 6.0 | 0.5 | 6.5 | 1.0 | 7.0 | 1.0 | 8.5 | 7.9 | ns |
| (PLH, (PHL | B to A | 0.6 | 6.8 | 0.8 | 6.9 | 0.9 | 7.5 | 1.0 | 8.5 | 6.1 | ns |
| t _{PZL} ,t _{PZH} | OE to A, OE to B | | 1.7 | | 1.7 | | 1.7 | | 1.7 | 1.7 | μs |
| t _{SKEW} | A Port, B Port ⁽¹²⁾ | | 1.0 | | 1.0 | | 1.0 | | 1.0 | 1.0 | ns |

$V_{CCA} = 1.1 \text{ V to } 1.3 \text{ V}, T_{A} = -40 \text{ to } 85^{\circ}\text{C}$

| Symbol | Parameter | V _{CCB} =3.0 V to 3.6 V | V _{CCB} =2.3 V to 2.7 V | V _{CCB} =1.65 V to 1.95 V | V _{CCB} =1.4 V to 1.6 V | V _{CCB} =1.1 V to 1.3 V | Unit |
|------------------------------------|--------------------------------|-------------------------------------|-------------------------------------|---------------------------------------|-------------------------------------|-------------------------------------|------|
| | | Тур. | Тур. | Тур. | Тур. | Тур. | |
| t _{PLH} ,t _{PHL} | A to B | 4.6 | 4.8 | 5.4 | 6.2 | 9.2 | ns |
| IPLH, IPHL | B to A | 6.8 | 7.0 | 7.4 | 7.8 | 9.1 | ns |
| t _{PZL} ,t _{PZH} | OE to A, OE to B | 1.7 | 1.7 | 1.7 | 1.7 | 1.7 | μs |
| tskew | A Port, B Port ⁽¹²⁾ | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 | ns |

Note:

12. Skew is the variation of propagation delay between output signals and applies only to output signals on the same port (A_n or B_n) and switching with the same polarity (LOW-to-HIGH or HIGH-to-LOW) (see Figure 10). Skew is guaranteed, but not tested.

Maximum Data Rate^(13, 14)

T_A=-40 to 85°C

| V _{CCA} | V _{CCB} =3.0 V to 3.6 V | V _{CCB} =2.3V to 2.7V | V _{CCB} =1.65V to 1.95V | V _{CCB} =1.4V to 1.6V | V _{CCB} =1.1V to 1.3V | Unit |
|----------------------------------|-------------------------------------|-----------------------------------|-------------------------------------|-----------------------------------|-----------------------------------|------|
| | Min. | Min. | Min. | Min. | Тур. | |
| V _{CCA} =3.00 to 3.60 V | 140 | 120 | 100 | 80 | 40 | Mbps |
| V _{CCA} =2.30 to 2.70 V | 120 | 120 | 100 | 80 | 40 | Mbps |
| V _{CCA} =1.65 to 1.95 V | 100 | 100 | 80 | 60 | 40 | Mbps |
| V _{CCA} =1.40 to 1.60 V | 80 | 80 | 60 | 60 | 40 | Mbps |
| V _{CCA} =1.10 to 1.30 V | Тур. | Тур. | Тур. | Тур. | Тур. | |
| VCCA-1.1010 1.00 V | 40 | 40 | 40 | 40 | 40 | Mbps |

Notes: 13. Maximum data rate is guaranteed, but not tested.

14. Maximum data rate is specified in megabits per second (see Figure 9). It is equivalent to two times the F-toggle frequency, specified in megahertz. For example, 100 Mbps is equivalent to 50MHz.

Capacitance

| Symbol | Parameter | | Conditions | T _A =+25°C Typical | Unit |
|------------------|----------------------------|----------|---|----------------------------------|------|
| CIN | Input Capacitance Control | Pin (OE) | V _{CCA} =V _{CCB} =GND | 3 | pF |
| C _{I/O} | Input/Output Capacitance | An | V _{CCA} =V _{CCB} =3.3 V, OE=GND | 4 | pF |
| 0/0 | | | | 5 | P |
| C _{pd} | Power Dissipation Capacita | nce | $V_{CCA}=V_{CCB}=3.3$ V, $V_{I}=0$ V or V_{CC} , f=10 MHz | 25 | pF |

I/O Architecture Benefit

The FXLA0104 I/O architecture benefits the end user, beyond level translation, in the following three ways:

Auto Direction without an external direction pin.

Drive Capacitive Loads. Automatically shifts to a higher current drive mode only during "Dynamic Mode" or HL / LH transitions.

Lower Power Consumption. Automatically shifts to low-power mode during "Static Mode" (no transitions), low ering pow er consumption.

The FXLA0104 does not require a direction pin. Instead, the I/O architecture detects input transitions on both side and automatically transfers the data to the corresponding output. For example, for a given channel, if both A and B side are at a static LOW, the direction has been established as $A \rightarrow B$, and a LH transition occurs on the B port; the FXLA0104 internal I/O architecture automatically changes direction from $A \rightarrow B$ to $B \rightarrow A$.

During HL / LH transitions, or "Dynamic Mode," a strong output driver drives the output channel in parallel with a weak output driver. After a typical delay of approximately 10 ns - 50 ns, the strong driver is turned off, leaving the weak driver enabled for holding the logic state of the channel. This weak driver is called the "bus

hold." "Static Mode" is when only the bus hold drives the channel. The bus hold can be over ridden in the event of a direction change. The strong driver allows the FXLA0104 to quickly charge and discharge capacitive transmission lines during dynamic mode. Static mode conserves pow er, where l_{CC} is typically < 5 μ A.

Bus Hold Minimum Drive Current

Specifies the minimum amount of current the bus hold driver can source/sink. The bus hold minimum drive current (II_{HOLD}) is V_{CC} dependent and guaranteed in the DC Electrical tables. The intent is to maintain a valid output state in a static mode, but that can be overridden when an input data transition occurs.

Bus Hold Input Overdrive Drive Current

Specifies the minimum amount of current required (by an external device) to overdrive the bus hold in the event of a direction change. The bus hold overdrive (I_{ODH} , I_{ODL}) is V_{CC} dependent and guaranteed in the DC Electrical tables.

Dynamic Output Current

The strength of the output driver during LH / HL transitions is referenced on page 8, Dynamic Output Electrical Characteristics, I_{OHD}, and I_{OLD}.

Test Diagrams

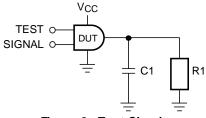


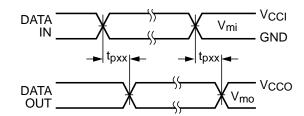
Figure 3. Test Circuit

Table 1. AC Test Conditions

| Test | Input Signal | Output Enable Control |
|------------|------------------|-----------------------|
| tplh, tphl | Data Pulses | VCCA |
| tpzL | 0V | LOW to HIGH Switch |
| tрzн | V _{CCI} | LOW to HIGH Switch |

Table 2. AC Load

| V _{cco} | C1 | R1 |
|-----------------------------------|-------|------|
| 1.2 V± 0.1 V | 15 pF | 1 MΩ |
| 1.5 V± 0.1 V | 15 pF | 1 MΩ |
| 1.8 V ± 0.15 V | 15 pF | 1 MΩ |
| $2.5~V\pm0.2~V$ | 15 pF | 1 MΩ |
| $3.3~\textrm{V}\pm0.3~\textrm{V}$ | 15 pF | 1 MΩ |

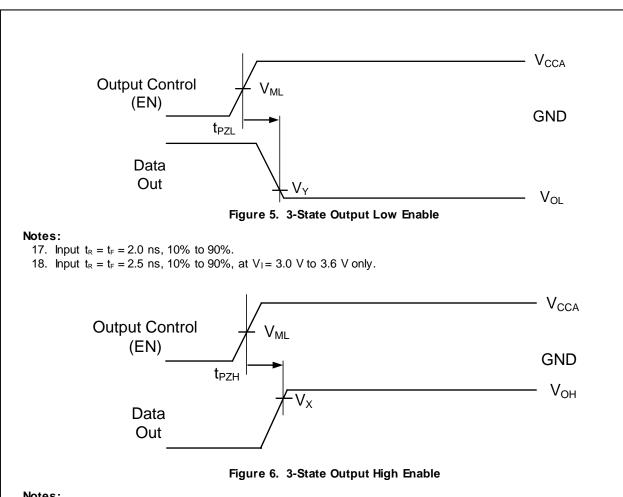




Notes:

15. Input $t_R = t_F = 2.0$ ns, 10% to 90%.

16. Input $t_R = t_F = 2.5$ ns, 10% to 90%, at V₁ = 3.0 V to 3.6 V only.



Notes:

19. Input $t_R = t_F = 2.0$ ns, 10% to 90%.

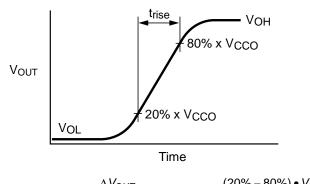
20. Input $t_R = t_F = 2.5$ ns, 10% to 90%, at $V_1 = 3.0$ V to 3.6 V only.

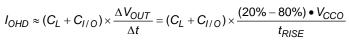
Table 3. **Test Measure Points**

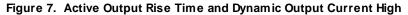
| Symbol | V _{DD} |
|---------------------------------|------------------------|
| V _{MI} ⁽²¹⁾ | V _{CCI} /2 |
| V _{MO} | V _{CCo} /2 |
| Vx | 0.9 x V _{CCo} |
| V _Y | 0.1 x V _{CCo} |

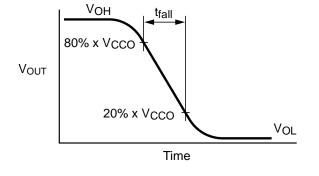
Note:

21. $V_{CCI}=V_{CCA}$ for control pin OE or $V_{MI}(V_{CCA}/2)$.

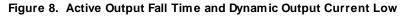


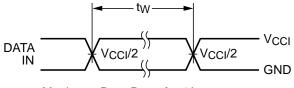






$$I_{OLD} \approx (C_L + C_{I/O}) \times \frac{\Delta V_{OUT}}{\Delta t} = (C_L + C_{I/O}) \times \frac{(80\% - 20\%) \bullet V_{CCO}}{t_{FALL}}$$





Maximum Data Rate, $f = 1/t_W$

Figure 9. Maximum Data Rate

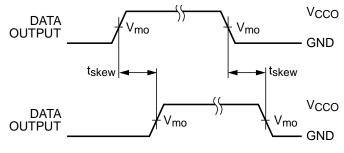
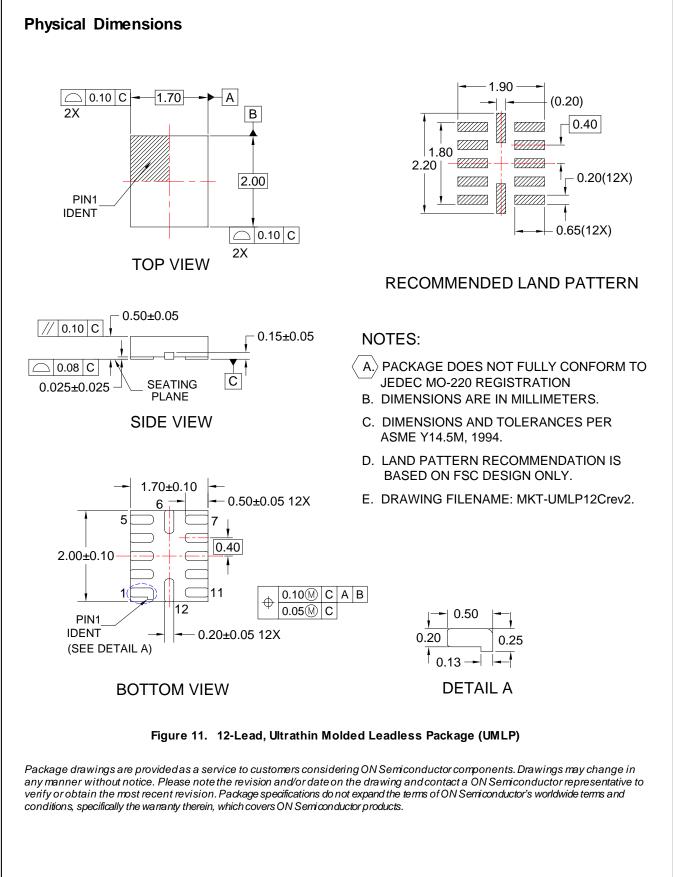


Figure 10. Output Skew Time

Note:

22. $t_{SKEW} = (t_{pHLmax} - t_{pHLmin}) \text{ or } (t_{pLHmax} - t_{pLHmin})$



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